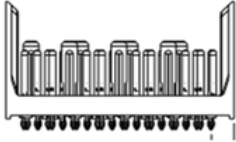
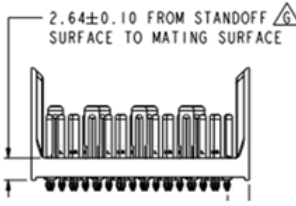


Product Name:	XCede		
	XCede Vertical Headers		
Product Manager:	Verghese John		
Subject:	Notification of Planned Change		
Distribution:	Global		
Type of Change:	Documentation Change		
Change Description:	<div style="display: flex; justify-content: space-around;"> <div style="text-align: center;"> <p>Before Change</p>  </div> <div style="text-align: center;"> <p>After Change</p>  <p>Adding the stack height dimension 2.64 +/- 0.10 mm which is measured from standoff surface to mating surface on all the XCEDE vertical header C DRW</p> </div> </div>		
Reason for Change:	Some customers have requested to add the stack height dimension 2.64 +/- 0.10 which is measured from standoffs surface to mating surface on all the Xcede vertical header customer drawing. This dimension is required to determine the distance of two PCBs after mating with receptacle.		
Affected Parts:	All XCede Vertical Headers		
Effective Date of Change:	October 15, 2016		
Last Time Buy Date:	NA		
Last Disty Return Date:	NA		
Last Time Shipment Date	NA		
Datasheet Attached?	Yes	<i>Revised sample drawings attached</i>	
Qual/Test Data Attached?	NA		
Samples Availability Date:	April	15	2016
Available Alternatives?	N/A		
Questions?	<i>Contact your local FCI Representative, or Product Manager</i>		
	<i>VERGHESE JOHN / Product Manager</i>		
	<i>+91-484-4090814 / verghese.john@fci.com</i>		

Note:

Customers should contact Product Manager (or their local FCI Representative) directly regarding any concern on the PCN. Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection .